

Sound Processor Series for Car Audio

Sound Processors with Built-in 3-band Equalizer



BD37531FV,BD37532FV,BD37533FV,BD37534FV

No.10085EAT06

Description

BD37531FV, BD37532FV, BD37533FV, BD37534FV are sound processors built-in 3-band equalizer for car audio. The functions are stereo input selector available to switch single end input and ground isolation input, input-gain control, main volume, loudness, 5ch fader volume, LPF for subwoofer(except BD37531FV), mixing input(except BD37531FV, BD37532FV). Moreover, "Advanced switch circuit", that is ROHM original technology, can reduce various switching noise (ex. No-signal, low frequency likes 20Hz & large signal inputs). "Advanced switch" makes control of microcomputer easier, and can construct high quality car audio system.

Features

- 1) Reduce switching noise of input gain control, mute, main volume, fader volume, bass, middle, treble, loudness by using advanced switch circuit [Possible to control all steps]
- 2) Built-in differential input selector that can make various combination of single-ended / differential input.
- 3) Built-in ground isolation amplifier inputs, ideal for external stereo input.
- 4) Built-in input gain controller reduces switching noise for volume of a portable audio input.
- 5) Decrease the number of external components by built-in 3-band equalizer filter, LPF for subwoofer (except BD37531FV), loudness filter. And, possible to control Q, Gv, fo of 3-band equalizer and fc of LPF, Gv of loudness by I²C BUS control freely
- 6) It is possible for the bass, middle, treble to the gain adjustment quantity of ±20dB and 1 dB step gain adjustment.
- 7) Terminals for the subwoofer outputs are equipped, and the audio signal outputs of front, back and subwoofer can be chosen with the I2C BUS control.
- 8) Built-in mixing input, mixing attenuator. (except BD37531FV, BD37532FV)
- 9) Bi-CMOS process is suitable for the design of low current and low energy. And it provides more quality for small scale regulator and heat in a set.
- 10) Package is SSOP-B28. Putting input-terminals together and output-terminals together can make PCB layout easier and can makes area of PCB smaller.
- 11) It is possible to control by 3.3V / 5V for I²C BUS.

Applications

It is the optimal for the car audio. Besides, it is possible to use for the audio equipment of mini Compo, micro Compo, TV etc with all kinds.

Line up matrix

Function	BD37531FV	BD37532FV	BD37533FV	BD37534FV	Specifications						
						d/Diff/Full-Diff	of single-end/dif	ff/full-diff as			
		0			IOIIOWS)	Single-End	Differential	Full-Differential			
Input					Mode 1	0	3	1			
selector	0		0	0	Mode 2	1	2	1			
					Mode 3	3	1	1			
					Mode 4	4	0	1			
					Mode 5	5	1	0			
					Mode 6	6 Table 4 Careb	0	0			
					- 020dD		ination of input s	selector			
Input gain	0	0	0	0	 0~20dB Possible to noise. 	•	ed switch" for pre	evention of switching			
Mute	0	0	0	0	noise.		-	evention of switching			
		_	_	_		79dB (1dB ste	• '				
Volume	0	0	0	O Possible to use "Advanced switch" for preve				evention of switching			
					noise.	ID (4 ID ()					
		0	0			dB (1dB step)					
Bass	0			0	• Q=0.5, 1, 1.5, 2 • fo=60, 80, 100, 120Hz						
							ed switch" at cha	anging gain			
						dB (1dB step)	ed Switch at Che	inging gain			
	_	_	_		• Q=0.75, 1	•					
Middle	0	0	0	0	• fo=500, 1k, 1.5k 2.5kHz						
							ed switch" at cha	anging gain			
						dB (1dB step)					
Troble	0	0			• Q=0.75, 1	.25					
Treble	0	0	0	0	• fo=7.5k, 1	0k, 12.5k, 15kl	Ηz				
					 Possible to 	o use "Advance	ed switch" at cha	anging gain			
						79dB(1dB step					
Fader	0	0	0	0	`	FV:0dB~-79	,				
						o use "Advance	ed switch" for pre	evention of switching			
					noise.	ID(4-ID · · ·					
						IB(1dB step)					
Loudness	0	0	0	0	• fo=250/40		ad awitch" for an	avantian of auttahins			
					noise.	o use Advance	eu switch for pre	evention of switching			
		-			• fc=55/85/1	SS.					
LPF	×	0	0	0	 Phase shi 		-				
- Monaural input											
Mixing						9dB(1dB step) , -∞				
iviixiiig	×	^			 Possible to 	o use "Advance	ed switch" for pre	evention of switching			
		noise.									
Level	×	×	×	0	· I2C BUS						
meter					 DC Outpu 	ıt					

● Absolute maximum ratings (Ta=25°C)

Item	Symbol	Rating	Unit
Power supply Voltage	VCC	10.0	V
Input voltage	Vin	VCC+0.3∼GND-0.3	V
Power Dissipation	Pd	1063 ※1	mW
Storage Temperature	Tastg	-55~+150	°C

^{**}This value decreases 8.5mW/°C for Ta=25°C or more.

ROHM standard board shall be mounted.

Thermal resistance θ ja = 117.6(°C/W)

ROHM Standard board

Size : 70×70×1.6(mm³)

Material: A FR4 grass epoxy board(3% or less of copper foil area)

Operating conditions

Item	Symbol	MIN	TYP	MAX	Unit
Power supply Voltage	VCC	7.0	_	9.5	V
Temperature	Topr	-40	_	+85	°C

Electrical characteristics

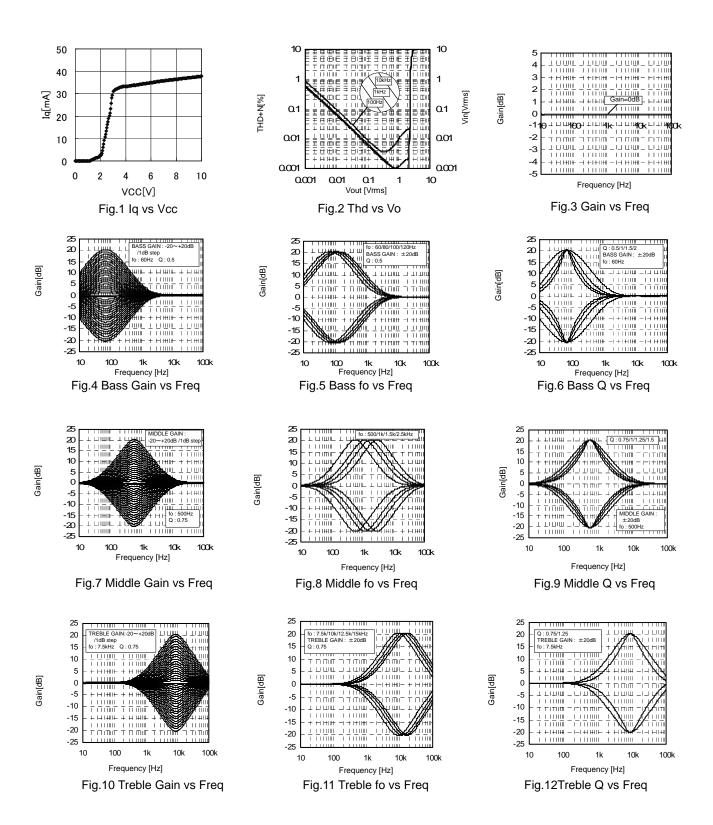
(Unless specified particularly, Ta=25°C, VCC=8.5V, f=1kHz, Vin=1Vrms, Rg=600 Ω , R_L=10k Ω , A1 input, Input gain 0dB, Mute off, Volume 0dB, Tone control 0dB, Loudness 0dB, LPF OFF(BD37532FV,BD37533FV,BD37534FV), Mixing OFF(BD37533FV,BD37534FV), Fader 0dB)

	ting OFF(BD37533FV,BD37534FV), Fade I	i UUD)		Limit		1	
BLOCK	ltem	Symbol	Min.	Тур.	Max.	Unit	Condition
	Current upon no signal	IQ	_	38	48	mA	No signal
	Voltage gain	G _V	-1.5	0	1.5	dB	Gv=20log(VOUT/VIN)
	Channel balance	CB	-1.5	0	1.5	dB	CB = GV1-GV2
	Total harmonic distortion 1 (FRONT,REAR)	THD+N1	-	0.001	0.05	%	VOUT=1Vrms BW=400-30KHz
	Total harmonic distortion 2 (SUBWOOFER)	THD+N2	_	0.002	0.05	%	VOUT=1Vrms BW=400-30KHz
_ 	Output noise voltage 1 (FRONT,REAR) *	V _{NO1}	-	3.8	15	μVrms	$Rg = 0\Omega$ BW = IHF-A
GENERAL	Output noise voltage 2 (SUBWOOFER) *	V _{NO2}	_	4.8	15	μVrms	$Rg = 0\Omega$ BW = IHF-A
9	Residual output noise voltage *	V _{NOR}	1	1.8	10	μVrms	Fader = -∞dB Rg = 0Ω BW = IHF-A
	Cross-talk between channels *	СТС	1	-100	-90	dB	$Rg = 0\Omega$ $CTC=20log(VOUT/VIN)$ $BW = IHF-A$
	Ripple rejection	RR	1	-70	-40	dB	f=1kHz VRR=100mVrms RR=20log(VCC IN/VOUT)
	Input impedance(A, B, C)	R _{IN_S}	70	100	130	kΩ	
	Input impedance (D, E)	R _{IN_D}	175	250	325	kΩ	
TOR	Maximum input voltage	V _{IM}	2.1	2.3	_	Vrms	VIM at THD+N(VOUT)=1% BW=400-30KHz
T SELECTOR	Cross-talk between selectors	CTS	_	-100	-90	dB	$Rg = 0\Omega$ CTS=20log(VOUT/VIN) BW = IHF-A
INPUT	Common mode rejection ratio * (D, E)	CMRR	50	65	ı	dB	XP1 and XN input XP2 and XN input CMRR=20log(VIN/VOUT) BW = IHF-A,[XX···D,E]
GAIN	Minimum input gain	G _{IN MIN}	-2	0	+2	dB	Input gain 0dB VIN=100mVrms Gin=20log(VOUT/VIN)
INPUT G	Maximum input gain	G _{IN MAX}	+18	+20	+22	dB	Input gain +20dB VIN=100mVrms Gin=20log(VOUT/VIN)
	Gain set error	G _{IN ERR}	-2	0	+2	dB	GAIN=+20~+1dB
MUTE	Mute attenuation *	G _{MUTE}	_	-105	-85	dB	Mute ON Gmute=20log(VOUT/VIN) BW = IHF-A
	Maximum gain	G _{V MAX}	13	15	17	dB	Volume = 15dB VIN=100mVrms Gv=20log(VOUT/VIN)
VOLUME	Maximum attenuation *	G _{V MIN}	_	-100	-85	dB	Volume = -∞dB Gv=20log(VOUT/VIN) BW = IHF-A
	Attenuation set error 1	G _{V ERR1}	-2	0	2	dB	GAIN & ATT=+15dB~-15dB
	Attenuation set error 2	G _{V ERR2}	-3	0	3	dB	ATT=-16dB~-47dB
	Attenuation set error 3	G _{V ERR3}	-4	0	4	dB	ATT=-48dB∼-79dB

\sim				1 ::4			
BLOCK	Item	Symbol	Min		Mov	Unit	Condition
B			Min.	Typ.	wax.		O-i 100-ID f 400I I-
	Maximum boost gain	G _{B BST}	18	20	22	dВ	
	Waxiiiidiii boost gairi	OB BS1	10	20	22	uБ	
BASS							,
B,	Maximum cut gain	G _{B CUT}	-22	-20	-18	dB	VIN=2Vrms
	Ç						G _B =20log (VOUT/VIN)
	Gain set error	G _{B ERR}	-2	Typ. Max. 20 22 dB			
		_					
	Maximum boost gain	G _{M BST}	18	20	22	dB	
MIDDLE							
ID II	Maximum cut gain	G _{м сит}	-22	-20	-18	dВ	
_	Maximum cut gain	GM CU1	-22	-20	-10	uБ	
	Gain set error	G _{M ERR}	-2	0	2	dB	
		OWILKK					
	Maximum boost gain	G _{T BST}	17	20	23	dB	
щ	-						G _T =20log (VOUT/VIN)
TREBLE							
🖺	Maximum cut gain	G _{T CUT}	-23	-20	-17	dB	
	0: 1						
	Gain set error	G _{T ERR}	-2				Gain=-20~+20dB f=10kHz
FV.	Input impedance	R _{IN_M}	19	27	35	KΩ	\/\\\ -4.THD.\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\
534	Maximum input voltage	V_{IM_M}	2.0	2.2	_	Vrms	
G 337!							
MIXING 3FV, BD3	Maximum attenuation	G _{MX MIN}	_	-100	-85	dB	
MI)	Maximum attendation	OIVIX IVIIN		.00	00	42	
MIXING (BD37533FV, BD37534FV)							ATT_16dB
303	Maximum gain	G _{MX MAX}	5	7	9	dB	
9							
	Maximum boost gain						
	(BD37532FV,BD37533FV,BD37534FV)	G _{F BST}	13	15	17	dB	
~							
)된	Maximum attenuation *	G _{F MIN}	_	-100	-90	dB	3 \
SUBWOOFER							BW = IHF-A
SUE	Gain set error	G _{F ERR}	-2	0	2	dB	Gain=+1~+15dB
\	(BD37532FV,BD37533FV,BD37534FV)						
FADER	Attenuation set error 1	G _{F ERR1}	-2				
FA	Attenuation set error 2	G _{F ERR2}	-3				
	Attenuation set error 3	G _{F ERR3}	-4	U			
	Output impedance	R _{OUT}	-	_	อบ	77	
	Maximum output voltage	V_{OM}	2	2.2	_	Vrms	
	-						
	Maximum gain	G	17	20	22	۲D	
LOUDNESS	Maximum gain	G _{L MAX}	17	20	۷۵	uБ	
LOT	Gain set error	GLERR	-2	Ω	2	dΒ	
-	Jain 36t 61101	OLERR	- <u>-</u>	U		UD.	O/MN=TZO TIUD
ete 4FV	Maximum output voltage	V_{LMAX}	2.8	3.1	3.5	V	
evel meter (BD37534FV)							
ve D37	Output offset voltage	V_{LOFF}	_	0	100	mV	
_	D 06004 (Average value detection effective value	- L OFF		•		•	

VP-9690A (Average value detection, effective value display) filter by Matsushita Communication is used for * measurement. Phase between input / output is same.

Electrical characteristic curves (Reference data)



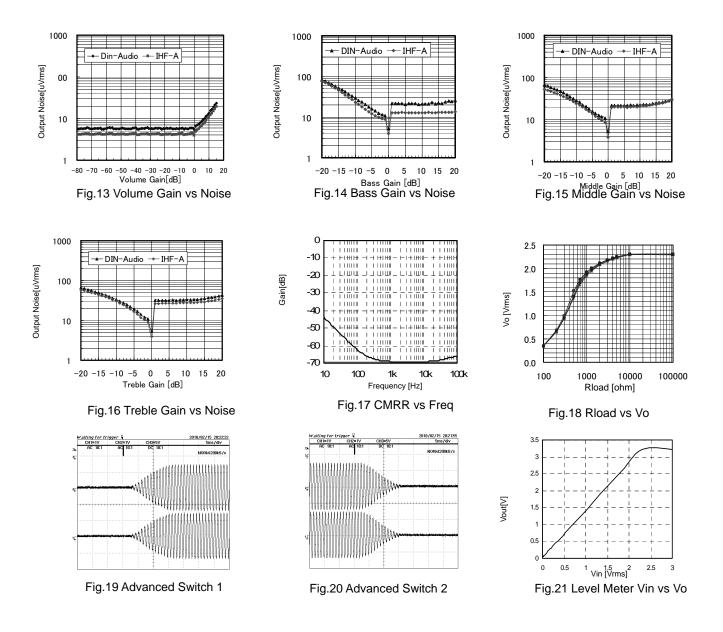


Fig.21: Level Meter function is available only BD37534FV

Block diagram and pin configuration

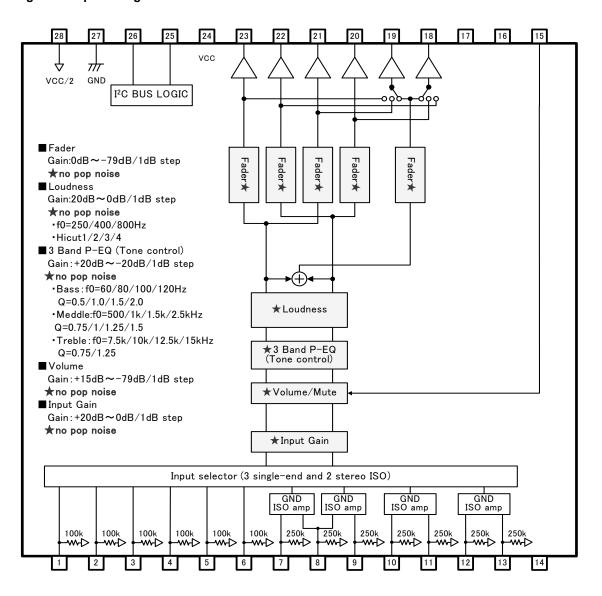


Fig.22 BD37531FV

Terminal No.	Terminal Name	Description	Terminal No.	Terminal Name	Description
1	A 1	A input terminal of 1ch	15	MUTE	External compulsory mute terminal
2	A2	A input terminal of 2ch	16	TEST2	Test Pin
3	B1	B input terminal of 1ch	17	TEST3	Test Pin
4	B2	B input terminal of 2ch	18	OUTS2	Subwoofer output terminal of 2ch
5	C1	C input terminal of 1ch	19	OUTS1	Subwoofer output terminal of 1ch
6	C2	C input terminal of 2ch	20	OUTR2	Rear output terminal of 2ch
7	DP1	D positive input terminal of 1ch	21	OUTR1	Rear output terminal of 1ch
8	DN	D negative input terminal	22	0UTF2	Front output terminal of 2ch
9	DP2	D positive input terminal of 2ch	23	0UTF1	Front output terminal of 1ch
10	EP1	E positive input terminal of 1ch	24	VCC	Power supply terminal
11	EN1	E negative input terminal of 1ch	25	SCL	I ² C Communication clock terminal
12	EN2	E negative input terminal of 2ch	26	SDA	I ² C Communication data terminal
13	EP2	E positive input terminal of 2ch	27	GND	GND terminal
14	TEST1	Test Pin	28	FIL	VCC/2 terminal

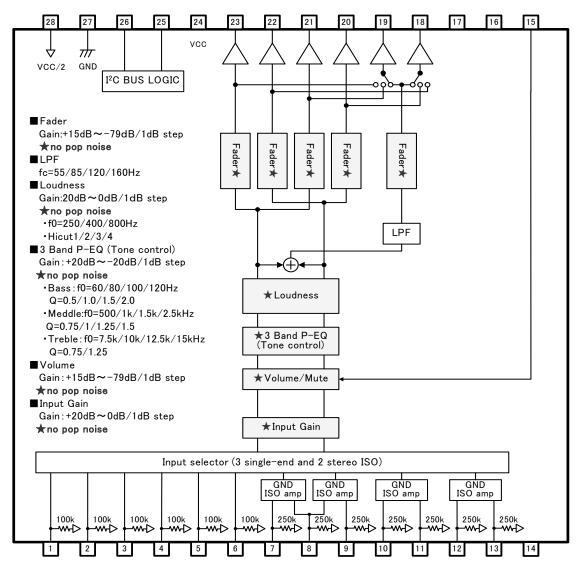


Fig.23 BD37532FV

Terminal No.	Terminal Name	Description	Terminal No.	Terminal Name	Description
1	A 1	A input terminal of 1ch	15	MUTE	External compulsory mute terminal
2	A2	A input terminal of 2ch	16	TEST2	Test Pin
3	B1	B input terminal of 1ch	17	TEST3	Test Pin
4	B2	B input terminal of 2ch	18	OUTS2	Subwoofer output terminal of 2ch
5	C1	C input terminal of 1ch	19	OUTS1	Subwoofer output terminal of 1ch
6	C2	C input terminal of 2ch	20	OUTR2	Rear output terminal of 2ch
7	DP1	D positive input terminal of 1ch	21	OUTR1	Rear output terminal of 1ch
8	DN	D negative input terminal	22	0UTF2	Front output terminal of 2ch
9	DP2	D positive input terminal of 2ch	23	0UTF1	Front output terminal of 1ch
10	EP1	E positive input terminal of 1ch	24	VCC	Power supply terminal
11	EN1	E negative input terminal of 1ch	25	SCL	I ² C Communication clock terminal
12	EN2	E negative input terminal of 2ch	26	SDA	I ² C Communication data terminal
13	EP2	E positive input terminal of 2ch	27	GND	GND terminal
14	TEST1	Test Pin	28	FIL	VCC/2 terminal

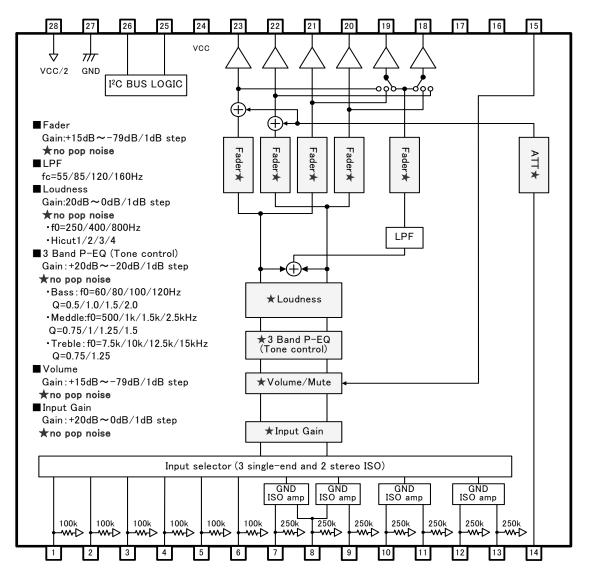


Fig.24 BD37533FV

Descriptions	oi terriiriai				
Terminal No.	Terminal Name	Description	Terminal No.	Terminal Name	Description
1	A1	A input terminal of 1ch	15	MUTE	External compulsory mute terminal
2	A2	A input terminal of 2ch	16	TEST1	Test Pin
3	B1	B input terminal of 1ch	17	TEST2	Test Pin
4	B2	B input terminal of 2ch	18	OUTS2	Subwoofer output terminal of 2ch
5	C1	C input terminal of 1ch	19	OUTS1	Subwoofer output terminal of 1ch
6	C2	C input terminal of 2ch	20	OUTR2	Rear output terminal of 2ch
7	DP1	D positive input terminal of 1ch	21	OUTR1	Rear output terminal of 1ch
8	DN	D negative input terminal	22	0UTF2	Front output terminal of 2ch
9	DP2	D positive input terminal of 2ch	23	0UTF1	Front output terminal of 1ch
10	EP1	E positive input terminal of 1ch	24	VCC	Power supply terminal
11	EN1	E negative input terminal of 1ch	25	SCL	I ² C Communication clock terminal
12	EN2	E negative input terminal of 2ch	26	SDA	I ² C Communication data terminal
13	EP2	E positive input terminal of 2ch	27	GND	GND terminal
14	MIN	Mixing input terminal	28	FIL	VCC/2 terminal

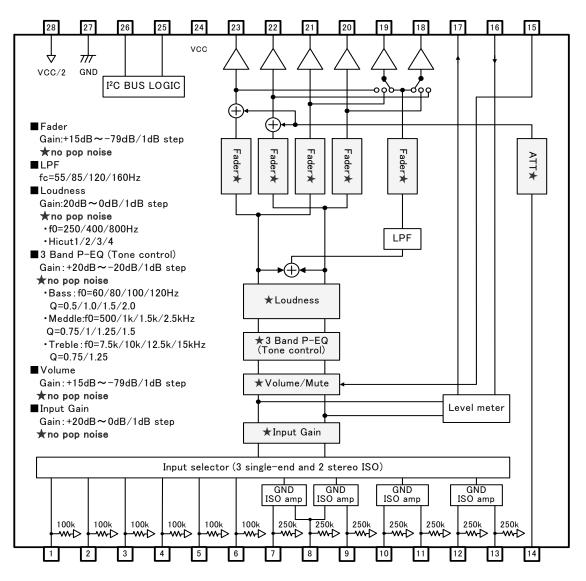


Fig.25 BD37534FV

Terminal No.	Terminal Name	Description	Terminal No.	Terminal Name	Description
1	A 1	A input terminal of 1ch	15	MUTE	External compulsory mute terminal
2	A2	A input terminal of 2ch	16	LRST	Level meter reset terminal
3	B1	B input terminal of 1ch	17	LOUT	Output terminal for Level meter
4	B2	B input terminal of 2ch	18	OUTS2	Subwoofer output terminal of 2ch
5	C1	C input terminal of 1ch	19	OUTS1	Subwoofer output terminal of 1ch
6	C2	C input terminal of 2ch	20	OUTR2	Rear output terminal of 2ch
7	DP1	D positive input terminal of 1ch	21	OUTR1	Rear output terminal of 1ch
8	DN	D negative input terminal	22	0UTF2	Front output terminal of 2ch
9	DP2	D positive input terminal of 2ch	23	0UTF1	Front output terminal of 1ch
10	EP1	E positive input terminal of 1ch	24	VCC	Power supply terminal
11	EN1	E negative input terminal of 1ch	25	SCL	I ² C Communication clock terminal
12	EN2	E negative input terminal of 2ch	26	SDA	I ² C Communication data terminal
13	EP2	E positive input terminal of 2ch	27	GND	GND terminal
14	MIN	Mixing input terminal	28	FIL	VCC/2 terminal

Timming Chart

CONTROL SIGNAL SPECIFICATION

(1) Electrical specifications and timing for bus lines and I/O stages

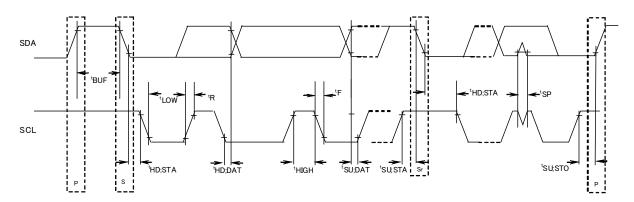


Fig.26 Definition of timing on the I²C-bus

Table 1 Characteristics of the SDA and SCL bus lines for I²C-bus devices (Unless specified particularly, Ta=25°C, VCC=8.5V)

	Parameter	Symbol	Fast-mod		
	Farallieter	Syllibol	Min.	Max.	Unit
1	SCL clock frequency	f SCL	0	400	kHz
2	Bus free time between a STOP and START condition	tBUF	1.3	ı	μS
3	Hold time (repeated) START condition. After this period, the first	tHD:STA	0. 6		μS
J	clock pulse is generated	LIID, STA	0. 0		μυ
4	LOW period of the SCL clock	tLOW	1.3	_	μS
5	HIGH period of the SCL clock	tHIGH	0.6	I	μS
6	Set-up time for a repeated START condition	tSU;STA	0.6	1	μS
7	Data hold time:	tHD;DAT	0.06*	1	μS
8	Data set-up time	tSU;DAT	120	-	ns
9	Set-up time for STOP condition	tSU;ST0	0. 6	_	μS

All values referred to VIH min. and VIL max. Levels (see Table 2).

^{*} A device must internally provide a hold time of at least 300 ns for the SDA signal (referred to the VIH min. of the SCL signal) in order to bridge the undefined region of the falling edge of SCL.

About 7(tHD;DAT), 8(tSU;DAT), make it the setup which a margin is fully in .

Table 2 Characteristics of the SDA and SCL I/O stages for I²C-bus devices

	Parameter	Cumbal	Fast-mode	devices	Unit
	Farallieter	Symbol	Min.	Max.	UIII L
10	LOW level input voltage:	VIL	-0.3	1	٧
11	HIGH level input voltage:	VIH	2. 3	5	٧
12	Pulse width of spikes which must be suppressed by the input filter.	tSP	0	50	ns
13	LOW level output voltage: at 3mA sink current	VOL1	0	0. 4	٧
14	Input current each $1/0$ pin with an input voltage between 0.4V and 4.5V.	li	-10	10	μΑ

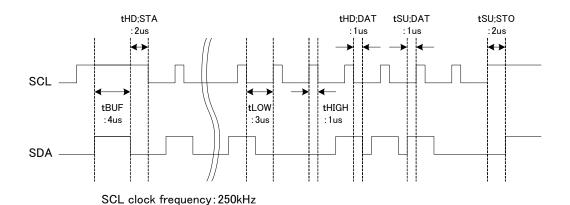


Fig. 27 A command timing example in the I2C data transmission

(2) I²C BUS FORMAT

	MSB LSB		MSB	LSB		MSB	LSB			
S	Slave Address	Α	Select	Address	Α		Data	Α	Р	
1bit	8bit	1bit 8		Bbit	1bit		8bit	1bit	1bit	
	S	= Start conditions (Recognition of start bit)								
	Slave Address = Recognition of slave address. 7 bits in upper order are volun								untary.	
The least significant bit is "L" due to writing.										
	Α	= ACKNOWLEDGE bit (Recognition of acknowledgement)								
	Select Address	= Select every of volume, bass and treble.								
	Data	= Data on every volume and tone.								
	Р	on (Recogni	tion	of stop	bit)					

(3) I²C BUS Interface Protocol

4 \	_		_	
1)	Ка	212	forn	1

.,								
S	Slave Address	Α	Select	Address	Α	Data	Α	Р
	MSB LSB		MSB	LSB	MS	B LSB	}	

2) Automatic increment (Select Address increases (+1) according to the number of data.

S	Slave Address	Α	Select	Address	Α	[Data1	Α	Dat	a2	Α	 Data	aN	Α	Р
	MSB LSB	M	SB	LSB	M	SB	LSB		MSB	LSB		MSB	LSE	3	

(Example) ①Data1 shall be set as data of address specified by Select Address.

②Data2 shall be set as data of address specified by Select Address +1.

3DataN shall be set as data of address specified by Select Address +N-1.

3) Configuration unavailable for transmission (In this case, only Select Address1 is set.

S	Slave	Address	Α	Select	Address1	Α	Data	A	Sel	lect Ad	dress 2	Α	Dat	:a	Α	Р
	MSB	LS	В	MSB	LSB	M	SB L	В	MSB		LSB	M	SB	LSB		
		(N	ote)	If any d	lata is tra	nsm	itted a	s Se	elect	Address	2 next	to	data,	it	is	
				recogniz	zed as data	ı, r	not as	Sele	ct Ad	dress 2						

(4) Slave address

MSB							LSB	
A6	A5	A4	A3	A2	A1	Α0	R/W	
1	0	0	0	0	0	0	0	80H

(5) Select Address & Data

BD37531FV

Items	Select Address	MSB			Da	ta			LSB		
i cellis	(hex)	D7	D6	D5	D4	D3	D2	D1	D0		
Initial setup 1	01	Advanced switch ON/OFF	0	of Input 0 Tone/Fade	witch time ain/Volume r/Loudness	0	1		switch time Mute		
Initial setup 2	02	0	0		Subwoofer Output 0 0				0		
Initial setup 3	03	0	0	0	Loudne	ess fo	0	0	1		
Input Selector	05	Full-diff Type	0	0		In	put select	or			
Input gain	06	Mute ON/OFF	0	O Input Gain							
Volume gain	20			Vo	olume Gain /	/ Attenuatio	on				
Fader 1ch Front	28				Fader At	tenuation					
Fader 2ch Front	29				Fader Attenuation						
Fader 1ch Rear	2A				Fader Attenuation						
Fader 2ch Rear	2B				Fader At	tenuation					
Fader Subwoofer	20				Fader At	tenuation					
Test Mode	30	1	1	1	1	1	1	1	1		
Bass setup	41	0	0	Bas	s fo	0	0	Bas	ss Q		
Middle setup	44	0	0	Midd	le fo	0	0	Mido	lle Q		
Treble setup	47	0	0	Treb	le fo	0	0	0	Treble Q		
Bass gain	51	Bass Boost/ Cut	0	0			Bass Gain				
Middle gain	54	Middle Boost/ Cut	0	0		N	Middle Gair	1			
Treble gain	57	Treble Boost/ Cut	0	0		1	Treble Gair	1			
Loudness Gain	75	0	Loudne	ss Hicut	icut Loudness Gain						
System Reset	FE	1	0	0	0	0	0	0	1		

Advanced switch

- 1. In function changing of the hatching part, it works Advanced switch.
- 2. Upon continuous data transfer, the Select Address is circulated by the automatic increment function, as shown below.

- 3. For the function of input selector and subwoofer output select etc, it is not corresponded for advanced switch. Therefore, please apply mute on the side of a set when changes these setting.
- 4. When using mute function of this IC at the time of changing input selector, please switch mute ON/OFF for waiting advanced-mute time.

BD37532FV

ltems	Select Address	MSB			Da	ta			LSB	
i cellis	(hex)	D7	D6	D5	D4	D3	D2	D1	D0	
Initial setup 1	01	Advanced switch ON/OFF	0	of Input G	witch time ain/Volume r/Loudness	0	1		witch time Mute	
Initial setup 2	02	LPF Phase	0		r Output ect	0	Sul	owoofer LPF	fc	
Initial setup 3	03	0	0	0	Loudne	ess fo	0	0	1	
Input Selector	05	Full-diff Type	0	0	Input selector					
Input gain	06	Mute ON/OFF	0	0	Input Gain					
Volume gain	20			Vo	olume Gain ,	/ Attenuati	on			
Fader 1ch Front	28			F	ader Gain /	/ Attenuation	on			
Fader 2ch Front	29			F	Fader Gain / Attenuation					
Fader 1ch Rear	2A			F	ader Gain /	/ Attenuation	on			
Fader 2ch Rear	2B			F	ader Gain /	/ Attenuation	on			
Fader Subwoofer	2C			F	ader Gain /	⁄ Attenuatio	on			
Test Mode	30	1	1	1	1	1	1	1	1	
Bass setup	41	0	0	Bass	s fo	0	0	Bas	s Q	
Middle setup	44	0	0	Midd	le fo	0	0	Midd	le Q	
Treble setup	47	0	0	Treb	le fo	0	0	0	Treble Q	
Bass gain	51	Bass Boost/ Cut	0	0			Bass Gain			
Middle gain	54	Middle Boost/ Cut	0	0	Middle Gain					
Treble gain	57	Treble Boost/ Cut	0	0	Treble Gain					
Loudness Gain	75	0	Loudnes	s Hicut	cut Loudness Gain					
System Reset	FE	1	0	0	0	0	0	0	1	

Advanced switch

- 1. In function changing of the hatching part, it works Advanced switch.
- 2. Upon continuous data transfer, the Select Address is circulated by the automatic increment function, as shown below.

$$01 \rightarrow 02 \rightarrow 03 \rightarrow 05 \rightarrow 06 \rightarrow 20 \rightarrow 28 \rightarrow 29 \rightarrow 2A \rightarrow 2B \rightarrow 2C$$

$$\rightarrow 30 \rightarrow 41 \rightarrow 44 \rightarrow 47 \rightarrow 51 \rightarrow 54 \rightarrow 57 \rightarrow 75$$

- 3. For the function of input selector and subwoofer output select etc, it is not corresponded for advanced switch. Therefore, please apply mute on the side of a set when changes these setting.
- 4. When using mute function of this IC at the time of changing input selector, please switch mute ON/OFF for waiting advanced-mute time.

BD37533FV

ltems	Select Address	MSB			Da	ta			LSB	
i cellis	(hex)	D7	D6	D5	D4	D3	D2	D1	D0	
Initial setup 1	01	Advanced switch ON/OFF	0	of Input G Tone/Fade	witch time ain/Volume r/Loudness king	0	1	Advanced s	witch time Mute	
Initial setup 2	02	LPF Phase	0		ofer Output O Subwoofer LPF fc					
Initial setup 3	03	0	0	0	Loudne	ess fo	0	0	1	
Input Selector	05	Full-diff Type	0	0	Input selector					
Input gain	06	Mute ON/OFF	0	0						
Volume gain	20			Vo	olume Gain ,	/ Attenuati	on			
Fader 1ch Front	28			F	Fader Gain / Attenuation					
Fader 2ch Front	29			F	Fader Gain / Attenuation					
Fader 1ch Rear	2A			F	ader Gain /	'Attenuatio	on			
Fader 2ch Rear	2B			F	ader Gain /	' A ttenuatio	on			
Fader Subwoofer	2C			F	ader Gain /	[′] Attenuatio	on			
Mixing	30			Mi	xing Gain ,	/ Attenuati	on			
Bass setup	41	0	0	Bass	s fo	0	0	Bas	s Q	
Middle setup	44	0	0	Midd	le fo	0	0	Midd	lle Q	
Treble setup	47	0	0	Treb	le fo	0	0	0	Treble Q	
Bass gain	51	Bass Boost/ Cut	0	0			Bass Gain			
Middle gain	54	Middle Boost/ Cut	0	0	Middle Gain					
Treble gain	57	Treble Boost/ Cut	0	0	Treble Gain					
Loudness Gain	75	0	Loudnes	s Hicut	cut Loudness Gain					
System Reset	FE	1	0	0	0	0	0	0	1	

Advanced switch

- 1. In function changing of the hatching part, it works Advanced switch.
- 2. Upon continuous data transfer, the Select Address is circulated by the automatic increment function, as shown below.

$$01 \rightarrow 02 \rightarrow 03 \rightarrow 05 \rightarrow 06 \rightarrow 20 \rightarrow 28 \rightarrow 29 \rightarrow 2A \rightarrow 2B \rightarrow 2C$$

$$30 \rightarrow 41 \rightarrow 44 \rightarrow 47 \rightarrow 51 \rightarrow 54 \rightarrow 57 \rightarrow 75$$

- 3. For the function of input selector and subwoofer output select etc, it is not corresponded for advanced switch. Therefore, please apply mute on the side of a set when changes these setting.
- 4. When using mute function of this IC at the time of changing input selector, please switch mute ON/OFF for waiting advanced-mute time.

BD37534FV

Items	Select Address	MSB			Da	ta			LSB		
i cellis	(hex)	D7	D6	D5	D4	D3	D2	D1	D0		
Initial setup 1	01	Advanced switch ON/OFF	0	of Input G Tone/Fade	witch time ain/Volume r/Loudness king	0	1		witch time Mute		
Initial setup 2	02	LPF Phase	Level Meter RESET		r Output ect	0	0 Subwoofer LPF fc				
Initial setup 3	03	0	0	0	Loudness fo 0 0 1						
Input Selector	05	Full-diff Type	0	0	Input selector						
Input gain	06	Mute ON/OFF	0	0	Input Gain						
Volume gain	20			Vo	Volume Gain / Attenuation						
Fader 1ch Front	28			F	ader Gain /	' A ttenuatio	enuation				
Fader 2ch Front	29			F	ader Gain /	' Attenuatio	on				
Fader 1ch Rear	2A			F	ader Gain /	' A ttenuatio	on				
Fader 2ch Rear	2B			F	ader Gain /	' Attenuatio	on				
Fader Subwoofer	20			F	ader Gain /	' Attenuatio	on				
Mixing	30			Mi	xing Gain ,	/ Attenuati	on				
Bass setup	41	0	0	Bass	s fo	0	0	Bas	s Q		
Middle setup	44	0	0	Midd	le fo	0	0	Midd	lle Q		
Treble setup	47	0	0	Treb	le fo	0	0	0	Treble Q		
Bass gain	51	Bass Boost/ Cut	0	0			Bass Gain				
Middle gain	54	Middle Boost/ Cut	0	0	Middle Gain						
Treble gain	57	Treble Boost/ Cut	0	0	Treble Gain						
Loudness Gain	75	0	Loudnes	s Hicut	t Loudness Gain						
System Reset	FE	1	0	0	0	0	0	0	1		

Advanced switch

- 1. In function changing of the hatching part, it works Advanced switch.
- 2. Upon continuous data transfer, the Select Address is circulated by the automatic increment function, as shown below.

$$01 \rightarrow 02 \rightarrow 03 \rightarrow 05 \rightarrow 06 \rightarrow 20 \rightarrow 28 \rightarrow 29 \rightarrow 2A \rightarrow 2B \rightarrow 2C$$

$$30 \rightarrow 41 \rightarrow 44 \rightarrow 47 \rightarrow 51 \rightarrow 54 \rightarrow 57 \rightarrow 75$$

- 3. For the function of input selector and subwoofer output select etc, it is not corresponded for advanced switch. Therefore, please apply mute on the side of a set when changes these setting.
- 4. When using mute function of this IC at the time of changing input selector, please switch mute ON/OFF for waiting advanced-mute time.

Select address 01 (hex)

╌.	(1111)								
ĺ	Time	MSB	Adv	/anced	swite	ch tim	e of N	Mute	LSB
	I IIIIC	D7	D6	D5	D4	D3	D2	D1	D0
Ī	0.6msec	A diverse a d		Advanced s	witch time			0	0
ĺ	1.Omsec	Advanced Switch	0	of Input g	gain/Volume	_	1	0	1
ĺ	1.4msec	ON/OFF	U	Tone/Fade	r/Loudness	0	1	1	0
ĺ	3.2msec	ON/ OFF		/Mix	xing			1	1

(Mixing is available only BD37533FV, BD37534FV)

Time	MSB	MSB Advanced switch time of Input gain/Volume/Tone/Fader/Loudness/Mixing									
	D7	D6	D5	D4	D3	D2	D1	D0			
4.7 msec	Advonced		0	0							
7.1 msec	Advanced Switch	0	0	1	0	1	Advance	d switch			
11.2 msec	ON/OFF	U	1	0	U	ı	Time o	of Mute			
14. 4 msec	ON/ OFF		1	1							

(Mixing is available only BD37533FV, BD37534FV)

Mode	MSB		Advan	ced sv	vitch	ON/OFF	=	LSB
Mode	D7	D6	D5	D4	D3	D2	D1	D0
0FF	0	0		witch time ain/Volume	0	1	Advance	d switch
ON	1	U	· ·	r/Loudness xing	0	l I	Time o	of Mute

(Mixing is available only BD37533FV, BD37534FV)

Select address 02(hex)

fc	MSB Subwoofer LPF fc							LSB
10	D7	D6	D5	D4	D3	D2	D1	D0
0FF						0	0	0
55Hz		اميروا				0	0	1
85Hz	LPF Phase	Level Meter	Subwoofer Output		0	0	1	0
120Hz	LFF Filase	RESET	Sel	ect	0	0	1	1
160Hz		INLOCI				1	0	0
Prohibition						0	ther settin	ıg

(Available only BD37532FV, BD37533FV, BD37534FV)

Mode	MSB Subwoofer Output Select							
Wode	D7	D6	D5	D4	D3	D2	D1	D0
LPF		Laval	0	0				
Front	I DE Dhasa	Level	0	1	_	CI	awaafau IDF	۔ ۔
Rear	LPF Phase	Meter RESET	1	0	0	Subwoofer LPF fc		10
Prohibition		NESET	1	1				

Mode	MSB		Lev	LSB					
Wode	D7	D6	D6 D5 D4 D3 D2 D1						
HOLD	LDE Dhana	0	Subwoofer output select		0	Subwoofer LPF fc			
RESET	LPF Phase	1			U Subwoo		owooler LPF	IC	

(Available only BD37534FV)

Phase	MSB				LSB			
Tilase	D7	D6	D5	D2	D1	DO		
0°	0	Level	Subwoofe	er output	0	Subwoofer I DE fo		۲.
180°	1	Meter RESET	select		0	Subwoofer LPF fc		TC

(Available only BD37532FV, BD37533FV, BD37534FV)

Select address 03(hex)

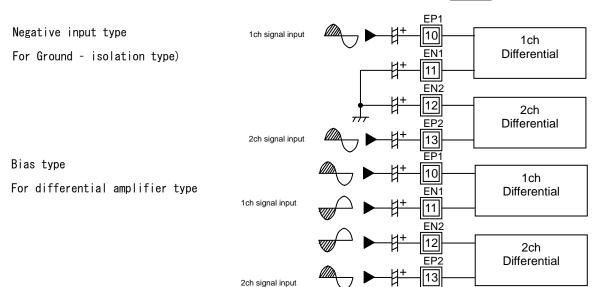
f0	MSB	MSB Loudness fo								
TU	D7	D6	D5	D4	D3	D2	D1	D0		
250Hz				0	0					
400Hz	0	0	_	0	1	0	0	1		
800Hz	0			1	0	U	U	I		
Prohibition				1	1					

Select address 05(hex)

Mode			MSB		In	put S	elect	or		LSB
Wiode	0UTF1	0UTF2	D7	D6	D5	D4	D3	D2	D1	D0
Α	A 1	A2				0	0	0	0	0
В	B1	B2				0	0	0	0	1
С	C1	C2				0	0	0	1	0
D single	DP1	DP2				0	0	0	1	1
E1 single	EP1	EN1	Full-di			0	1	0	1	0
E2 single	EN2	EP2	ff bias	0	0	0	1	0	1	1
A diff	A 1	B1	type	U	U	0	1	1	1	1
C diff	B2	C2	select			1	0	0	0	0
D diff	DP1	DP2				0	0	1	1	0
E full diff	EP1	EP2				0	1	0	0	0
In	put SHORT					0	1	0	0	1
Prohibition							01	ther setti	ng	

Input SHORT: The input impedance of each input terminal is lowered from $100k\Omega$ (TYP) to $6~k\Omega$ (TYP). (For quick charge of coupling capacitor)

Mode	MSB	F	ect	LSB				
Mode	D7	D6	D5	D4	D3	D2	D1	DO
Negative Input	0	0	0	0	Input			
Bias	1	U	U	"	Selector			



Select address 06 (hex)

Gain	MSB			Input	Gain			LSB
daili	D7	D6	D5	D4	D3	D2	D1	DO
0dB				0	0	0	0	0
1dB				0	0	0	0	1
2dB				0	0	0	1	0
3dB				0	0	0	1	1
4dB				0	0	1	0	0
5dB				0	0	1	0	1
6dB				0	0	1	1	0
7dB				0	0	1	1	1
8dB				0	1	0	0	0
9dB				0	1	0	0	1
10dB				0	1	0	1	0
11dB	Mute	0	0	0	1	0	1	1
12dB	ON/OFF	U	U	0	1	1	0	0
13dB				0	1	1	0	1
14dB				0	1	1	1	0
15dB				0	1	1	1	1
16dB				1	0	0	0	0
17dB				1	0	0	0	1
18dB				1	0	0	1	0
19dB				1	0	0	1	1
20dB				1	0	1	0	0
				1	1	0	1	1
Prohibition				:	:	:	:	:
				1	1	1	1	1

Mode	MSB Mute ON/OFF								
Wode	D7	D6	D5	D4	D3	D2	D1	D0	
0FF	0	0	0	Input Gain					
ON	1	U	U			IIIput daili			

Select address 20, 28, 29, 2A, 2B, 2C (hex)

Gain & ATT	MSB	Vol,	Fade	r Gair	ı / At	tenuat	ion	LSB
daill & All	D7	D6	D5	D4	D3	D2	D1	D0
	0	0	0	0	0	0	0	0
Prohibition	0	0	0	0	0	0	0	1
Prombilion	:	:	:	:	:	:	:	:
	0	1	1	1	0	0	0	0
15dB	0	1	1	1	0	0	0	1
14dB	0	1	1	1	0	0	1	0
13dB	0	1	1	1	0	0	1	1
:	:		:	:	:	:	:	:
−77dB	1	1	0	0	1	1	0	1
-78dB	1	1	0	0	1	1	1	0
−79dB	1	1	0	0	1	1	1	1
	1	1	0	1	0	0	0	0
Prohibition	:	:	:	:	:	:	:	:
	1	1	1	1	1	1	1	0
-∞dB	1	1	1	1	1	1	1	1

(About BD37531FV, only OdB∼-∞dB are available)

Select address 30(hex)

Gain & ATT	MSB	M i	xing	Gain /	/ Atte	nuatio	on	LSB
daill & All	D7	D6	D5	D4	D3	D2	D1	D0
	0	0	0	0	0	0	0	0
Prohibition	0	0	0	0	0	0	0	1
Prombilion	:	:	:	:	:	:	:	:
	0	1	1	1	1	0	0	0
7dB	0	1	1	1	1	0	0	1
6dB	0	1	1	1	1	0	1	0
5dB	0	1	1	1	1	0	1	1
:	:	• •	••	:	:	:	:	:
−77dB	1	1	0	0	1	1	0	1
-78dB	1	1	0	0	1	1	1	0
−79dB	1	1	0	0	1	1	1	1
	1	1	0	1	0	0	0	0
Prohibition	:	:	:	:	:			
	1	1	1	1	1	1	1	0
MIX OFF	1	1	1	1	1	1	1	1

(Available only BD37533FV, BD37534FV)

Select address 41 (hex)

Q factor	MSB		Ва	ss Q	LSB			
Q TACLUI	D7	D6	D5	D4	D3	D2	D1	D0
0. 5					0		0	0
1. 0		0	Poo	Bass fo		0	0	1
1. 5		U Bas		8 10	0	0	1	0
2. 0							1	1

fo	MSB			Bass	LSB				
ТО	D7	D6	D5	D4	D3	D2	D1	D0	
60Hz			0	0					
80Hz	0	_	0	1	0	0	Bass	ISS	
100Hz		0	1	0	7 "	U	Bass Q factor		
120Hz			1	1					

Select address 44(hex)

Q factor	MSB		Mid	dle G) fact	or	LSB			
Q TACLOT	D7	D6	D5	D4	D3	D2	D1	D0		
0. 75							0	0		
1. 0	0	0	Midd	lo fo	0	0	0	1		
1. 25	U	U	Wildu	Middle fo		U	1	0		
1. 5							1	1		

fo	MSB		N	/liddle	LSB				
ТО	D7	D6	D5	D4	D3	D2	D1	DO DO	
500Hz			0	0	0 0				
1kHz	0	0	0	1		Mid	Middle		
1. 5kHz	U	0	1	0		U	Middle Q factor		
2. 5kHz			1	1					

Select address 47 (hex)

Q factor	MSB		Tre	ble	Q fact	or	LSB		
	D7	D6	D5	D4	D3	D2	D1	D0	
0. 75	0	0	Trob	le fo	0	٥	0	0	
1. 25	U	U	rreb	16 10	U	U	U	1	

fo	MSB			Treble	LSB			
10	D7	D6	D5	D4	D3	D2	D1	D0
7. 5kHz			0	0				
10kHz	_	0	0	1	0	0	0	Treble
12. 5kHz		0	1	0		U	U	Q factor
15kHz			1	1				

Select address 51, 54, 57 (hex)

Gain	MSB	В	ass/Mi	ddle/	Treble	Gain		LSB
daili	D7	D6	D5	D4	D3	D2	D1	D0
0dB				0	0	0	0	0
1dB				0	0	0	0	1
2dB				0	0	0	1	0
3dB				0	0	0	1	1
4dB				0	0	1	0	0
5dB				0	0	1	0	1
6dB				0	0	1	1	0
7dB				0	0	1	1	1
8dB				0	1	0	0	0
9dB				0	1	0	0	1
10dB	Bass/			0	1	0	1	0
11dB	Middle/			0	1	0	1	1
12dB	Treble	0	0	0	1	1	0	0
13dB	Boost			0	1	1	0	1
14dB	/cut			0	1	1	1	0
15dB				0	1	1	1	1
16dB]			1	0	0	0	0
17dB				1	0	0	0	1
18dB]			1	0	0	1	0
19dB	ĺ			1	0	0	1	1
20dB				1	0	1	0	0
				1	0	1	0	1
Prohibition				:	:	:	:	:
Prohibition				1	1	1	1	0
				1	1	1	1	1

Mode	MSB	Bass	ut	LSB					
Widde	D7	D6	D5	D4	D3	D2	D1	D0	
Boost	0	0	٥		Ross /N	liddla/Trabl	o Goin		
Cut	1	U	0	Bass/Middle/Treble Gain					

Select address 75 (hex)

Mode	MSB Loudness Hicut									
Mode	D7	D6	D5	D4	D3	D2	D1	D0		
Hicut1		0	0							
Hicut2	0	0	1	Loudness Gain						
Hicut3] "	1	0							
Hicut4		1	1							

Gain	MSB		L	oudne	ss Gai	n		LSB		
daili	D7	D6	D5	D4	D3	D2	D1	D0		
0dB				0	0	0	0	0		
1dB				0	0	0	0	1		
2dB				0	0	0	1	0		
3dB				0	0	0	1	1		
4dB				0	0	1	0	0		
5dB				0	0	1	0	1		
6dB				0	0	1	1	0		
7dB				0	0	1	1	1		
8dB		1				0	1	0	0	0
9dB					1	0	0	1		
10dB				0	1	0	1	0		
11dB	0	Loudness Hicut		0	1	0	1	1		
12dB	U	Loudnes	S HIGUL	0	1	1	0	0		
13dB				0	1	1	0	1		
14dB					0	1	1	1	0	
15dB				0	1	1	1	1		
16dB				1	0	0	0	0		
17dB				1	0	0	0	1		
18dB				1	0	0	1	0		
19dB				1	0	0	1	1		
20dB				1	0	1	0	0		
				1	0	1	0	1		
Prohibition					:	:	:	:		
				1	1	1	1	1		

: Initial condition

(6) About power on reset

At on of supply voltage circuit made initialization inside IC is built-in. Please send data to all address as initial data at supply voltage on. And please supply mute at set side until this initial data is sent.

ltem	Svmbol		Limit		Unit	Condition				
i ceiii	Syllibol	Min.	Тур.	Max.	UIII L	John Cron				
Rise time of VCC	Trise	33	_	_	usec	VCC rise time from OV to 5V				
VCC voltage of release power on reset	Vpor	-	4. 1	-	٧					

(7)) About external compulsory mute terminal

Mute is possible forcibly than the outside after input again department, by the setting of the MUTE terminal.

Mute Voltage Condition	Mode
GND∼1. 0V	MUTE ON
2. 3V~VCC	MUTE OFF

Establish the voltage of MUTE in the condition to have been defined.

Volume / Fader volume / Mixing attenuation of the details

(dB)	D7	D6	D5	D4	D3	D2	D1	D0		(dB)	D7	D6	D5	D4	D3	D2	D1	D0
+15	0	1	1	1	0	0	0	1		-33	1	0	1	0	0	0	0	1
+14	0	1	1	1	0	0	1	0		-34	1	0	1	0	0	0	1	0
+13	0	1	1	1	0	0	1	1		-35	1	0	1	0	0	0	1	1
+12	0	1	1	1	0	1	0	0		-36	1	0	1	0	0	1	0	0
+11	0	1	1	1	0	1	0	1		-37	1	0	1	0	0	1	0	1
+10	0	1	1	1	0	1	1	0		-38	1	0	1	0	0	1	1	0
+9	0	1	1	1	0	1	1	1		-39	1	0	1	0	0	1	1	1
+8	0	1	1	1	1	0	0	0		-40	1	0	1	0	1	0	0	0
+7	0	1	1	1	1	0	0	1		-41	1	0	1	0	1	0	0	1
+6	0	1	1	1	1	0	1	0		-41 -42	1	0	1	0	1	0	1	0
+5	0	1	1	1	1	0	1	1		-43	1	0	1	0	1	0	1	1
+5	0	1	1	1	1	1	0	0		-43 -44	1	0	1	0	1	1	0	0
		1				-	0			-44 -45	1	0		0			0	1
+3	0	-	1	1	1	1		1		-45 -46			1		1	1		
+2		1	1	1	1	1	1	0			1	0	1	0	1	1	1	0
+1	0	1	1	1	1	1	1	1		-47 -48	1	0	1	0	1	1	1	1
0	1	0	0	0	0	0	0	0			1	0	1	1	0	0	0	0
-1	1	0	0	0	0	0	0	1		-49 	1	0	1	1	0	0	0	1
-2	1	0	0	0	0	0	1	0		-50	1	0	1	1	0	0	1	0
-3	1	0	0	0	0	0	1	1		-51	1	0	1	1	0	0	1	1
-4	1	0	0	0	0	1	0	0		-52	1	0	1	1	0	1	0	0
-5	1	0	0	0	0	1	0	1		-53	1	0	1	1	0	1	0	1
-6	1	0	0	0	0	1	1	0		-54	1	0	1	1	0	1	1	0
-7	1	0	0	0	0	1	1	1		-55	1	0	1	1	0	1	1	1
-8	1	0	0	0	1	0	0	0		-56	1	0	1	1	1	0	0	0
-9	1	0	0	0	1	0	0	1		-57	1	0	1	1	1	0	0	1
-10	1	0	0	0	1	0	1	0		-58	1	0	1	1	1	0	1	0
-11	1	0	0	0	1	0	1	1		-59	1	0	1	1	1	0	1	1
-12	1	0	0	0	1	1	0	0		-60	1	0	1	1	1	1	0	0
-13	1	0	0	0	1	1	0	1		-61	1	0	1	1	1	1	0	1
-14	1	0	0	0	1	1	1	0		-62	1	0	1	1	1	1	1	0
-15	1	0	0	0	1	1	1	1		-63	1	0	1	1	1	1	1	1
-16	1	0	0	1	0	0	0	0		-64	1	1	0	0	0	0	0	0
-17	1	0	0	1	0	0	0	1		-65	1	1	0	0	0	0	0	1
-18	1	0	0	1	0	0	1	0		-66	1	1	0	0	0	0	1	0
-19	1	0	0	1	0	0	1	1		-67	1	1	0	0	0	0	1	1
-20	1	0	0	1	0	1	0	0		-68	1	1	0	0	0	1	0	0
-21	1	0	0	1	0	1	0	1		-69	1	1	0	0	0	1	0	1
-22	1	0	0	1	0	1	1	0		-70	1	1	0	0	0	1	1	0
-23	1	0	0	1	0	1	1	1		-71	1	1	0	0	0	1	1	1
-24	1	0	0	1	1	0	0	0		-72	1	1	0	0	1	0	0	0
-25	1	0	0	1	1	0	0	1		-73	1	1	0	0	1	0	0	1
-26	1	0	0	1	1	0	1	0		-74	1	1	0	0	1	0	1	0
-27	1	0	0	1	1	0	1	1		-75	1	1	0	0	1	0	1	1
-28	1	0	0	1	1	1	0	0		-76	1	1	0	0	1	1	0	0
-29	1	0	0	1	1	1	0	1		-77	1	1	0	0	1	1	0	1
-30	1	0	0	1	1	1	1	0		-78	1	1	0	0	1	1	1	0
-31	1	0	0	1	1	1	1	1		-79	1	1	0	0	1	1	1	1
-32	1	0	1	0	0	0	0	0		-∞	1	1	1	1	1	1	1	1
About BD375	31FV	Fade	er Vol	ume o	nlv C	ldB ~ −	-∞dB	are a	vaila	ble								

About BD37531FV, Fader Volume only OdB $\sim\!\!-\infty$ dB are available.

Mixing is available only BD37533FV, BD37534FV. Adjustable range is $+7dB \sim -\infty dB$.

About Level meter (available only BD37534FV)

(1) The operation of circuit

Level meter is a function which gives DC voltage proportional to the size of signal of sound. It detects the peak level of signal and keeps the peak level, so that it is possible to monitor the size of signal by resetting DC voltage kept with suitable interval.

(2) The way to reset level meter output

Please send reset data through I²C BUS

When reset output of level meter: Send $D6 = 10^{\circ}$ of select address $02 \, (\text{hex})$.

When cancel of output reset of level meter (HOLD) $\cdots \rightarrow$ Send D6 = "0" of select address O2(hex).

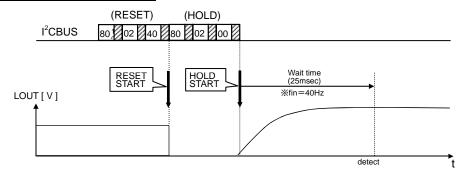
(3) The settings about period of reset

Peak hold operation will start after HOLD data is transmitted. Set the WAIT time after HOLD data transmission according to the frequency bandwidth detected.

WAIT time must be set to a minimum of one cycle over the detected frequency bandwidth.

Ex) Detected frequency bandwidth is above 40Hz, [40Hz = 25ms = WAIT time]

Transmission Example by I2C BUS



Application circuit

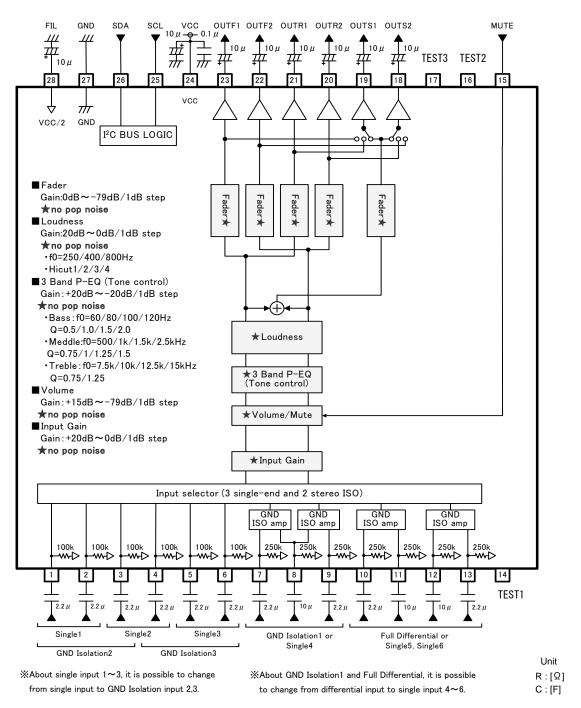


Fig. 28 BD37531FV

- ① Please connect the decoupling capacitor of a power supply in the shortest distance as much as possible to GND.
- 2 Lines of GND shall be one-point connected.
- ③ Wiring pattern of Digital shall be away from that of analog unit and cross-talk shall not be acceptable.
- 4 Lines of SCL and SDA of I^2 C BUS shall not be parallel if possible. The lines shall be shielded, if they are adjacent to each other.
- ⑤ Lines of analog input shall not be parallel if possible. The lines shall be shielded, if they are adjacent to each other.
- ⑥ About TEST pin(14, 16, 17pin), please use with OPEN.

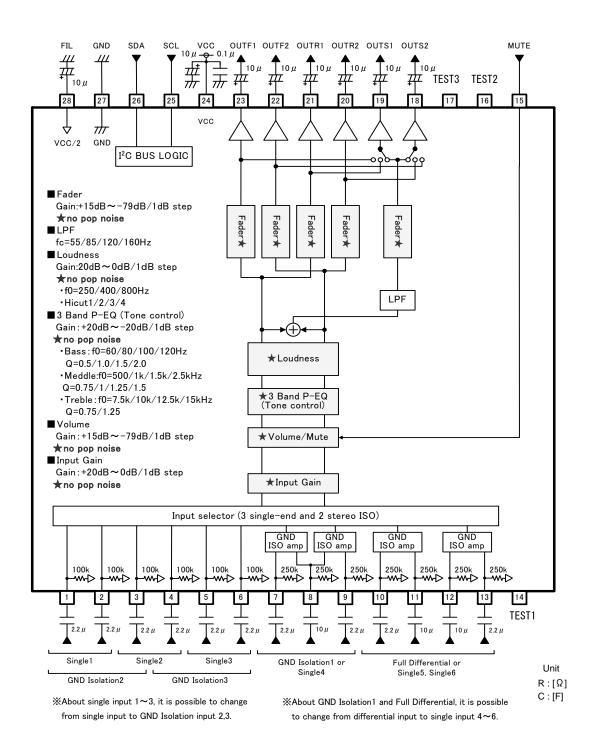


Fig. 29 BD37532FV

- ① Please connect the decoupling capacitor of a power supply in the shortest distance as much as possible to GND.
- ② Lines of GND shall be one-point connected.
- ③ Wiring pattern of Digital shall be away from that of analog unit and cross-talk shall not be acceptable.
- 4 Lines of SCL and SDA of 12C BUS shall not be parallel if possible. The lines shall be shielded, if they are adjacent to each other.
- ⑤ Lines of analog input shall not be parallel if possible. The lines shall be shielded, if they are adjacent to each other.
- 6 About TEST pin(14, 15, 16pin), please use with OPEN.

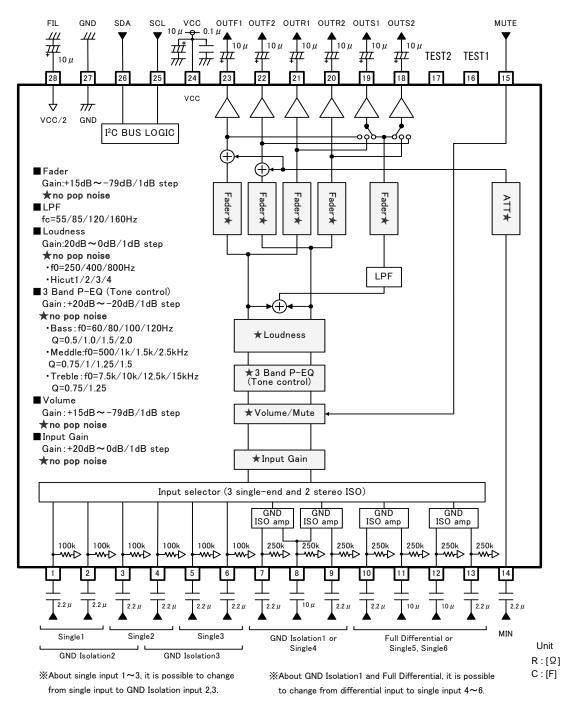


Fig. 30 BD37533FV

- ① Please connect the decoupling capacitor of a power supply in the shortest distance as much as possible to GND.
- 2 Lines of GND shall be one-point connected.
- ③ Wiring pattern of Digital shall be away from that of analog unit and cross-talk shall not be acceptable.
- 4 Lines of SCL and SDA of 12C BUS shall not be parallel if possible. The lines shall be shielded, if they are adjacent to each other.
- ⑤ Lines of analog input shall not be parallel if possible. The lines shall be shielded, if they are adjacent to each other.
- 6 About TEST pin(16,17pin), please use with OPEN.

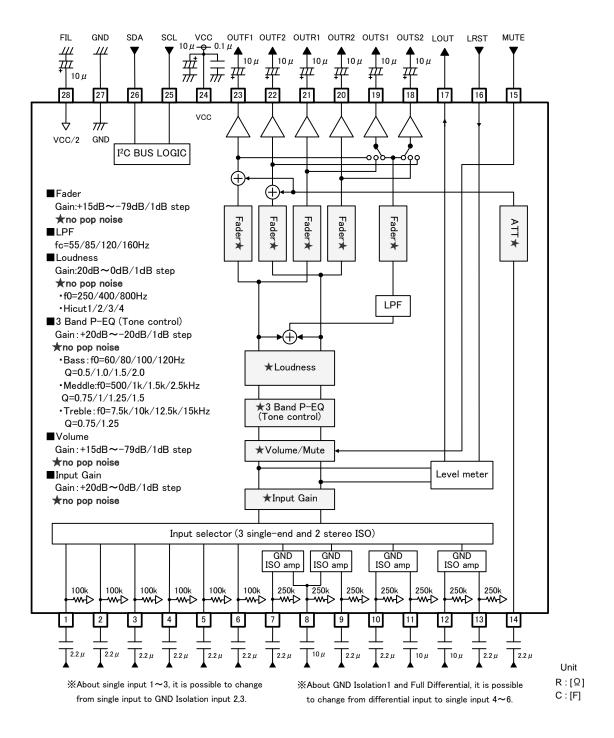


Fig. 31 BD37534FV

- ① Please connect the decoupling capacitor of a power supply in the shortest distance as much as possible to GND.
- ② Lines of GND shall be one-point connected.
- ③ Wiring pattern of Digital shall be away from that of analog unit and cross-talk shall not be acceptable.
- 4 Lines of SCL and SDA of I²C BUS shall not be parallel if possible. The lines shall be shielded, if they are adjacent to each other.
- (5) Lines of analog input shall not be parallel if possible. The lines shall be shielded, if they are adjacent to each other.

●Interfaces

Terminal No.	Terminal Name	Terminal Voltage	Equivalent Circuit	Terminal Description
1 2 3 4 5 6	A1 A2 B1 B2 C1 C2	4. 25	Voc VOC VO VO VO VO VO VO VO VO VO VO	A terminal for signal input. The input impedance is 100kΩ(typ).
7 8 9 10 11 12 13	DP1 DN DP2 EP1 EN1 EN2 EP2	4. 25	Vcc	Input terminal available to single/Differential mode. The input impedance is 250kΩ(typ).
15	MUTE	_	Vcc	A terminal for external compulsory mute. If terminal voltage is High level, the mute is off. And if the terminal voltage is Low level, the mute is on.
18 19 20 21 22 23	OUTS2 OUTS1 OUTR2 OUTR1 OUTF2 OUTF1	4. 25	Vcc GND GND	A terminal for fader and Subwoofer output.
17	LOUT	0~3.3	VCC A 10k	A terminal for level meter output (BD37534FV) Output impedance is $10k\Omega$ (typ).

The figure in the pin explanation and input/output equivalent circuit is reference value, it doesn't guarantee the value.

Terminal No.	Terminal Name	Terminal Voltage	Equivalent Circuit	Terminal Description	
24	VCC	8. 5		Power supply terminal.	
25	SCL	_	Vcc O J 1.65V	A terminal for clock input of I ² C BUS communication.	
26	SDA	_	Vcc O GND GND	A terminal for data input of I ² C BUS communication.	
27	GND	0		Ground terminal.	
28	FIL	4. 25	Vcc	Voltage for reference bias of analog signal system. The simple precharge circuit and simple discharge circuit for an external capacitor are built in.	
14	MIN	4. 25	Vcc	A terminal for signal input (BD37533FV, BD37534FV) The input impedance is 27kΩ(typ).	
14 16 17	TEST	-		TEST terminal (BD37531FV, BD37532FV, BD37533FV) About BD37531FV and BD37532FV, 14, 16, 17pin are TEST Pin. About BD37533FV, 16, 17pin are TEST Pin.	

The figure in the pin explanation and input/output equivalent circuit is reference value, it doesn't guarantee the value.

Notes for use

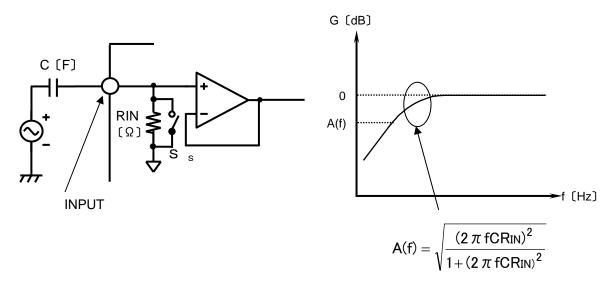
1. Absolute maximum rating voltage

When it impressed the voltage on VCC more than the absolute maximum rating voltage, circuit currents increase rapidly, and there is absolutely a case to reach characteristic deterioration and destruction of a device. In particular in a serge examination of a set, when it is expected the impressing serge at VCC terminal (24pin), please do not impress the large and over the absolute maximum rating voltage (including a operating voltage + serge ingredient (around 14V)).

2. About a signal input part

1) About constant set up of input coupling capacitor

In the signal input terminal, the constant setting of input coupling capacitor C(F) be sufficient input impedance $R_{IN}(\Omega)$ inside IC and please decide. The first HPF characteristic of RC is composed.



2) About the input selector SHORT

SHORT mode is the command which makes switch S_{SH} =0N an input selector part and input impedance RIN of all terminals, and makes resistance small. Switch S_{SH} is OFF when not choosing a SHORT command. A constant time becomes small at the time of this command twisting to the resistance inside the capacitor connected outside and LSI. The charge time of a capacitor becomes short. Since SHORT mode turns ON the switch of S_{SH} and makes it low impedance, please use it at the time of a non-signal.

3. About Mute terminal (15pin) when power supply is off

Any voltage shall not be supplied to Mute terminal (15pin) when power-supply is off. Please insert a resistor (about $2.2k\Omega$) to Mute terminal in series, if voltage is supplied to mute terminal in case. (Please refer Application Circuit Diagram.)

4. About TEST Pin

About TEST Pin, please use with OPEN.

About BD37531FV and BD37532FV, 14,16,17pin are TEST Pin. About BD37533FV, 16,17pin are TEST Pin.

5. About Mixing (BD3753FV, BD37534FV)

• About specification of Fader $-\infty$ at Mixing ON.

Mixed signal is added to Main signal after Fader Gain (+15 \sim -79dB) like the following figure. When Fader is made a set up in $-\infty$, the signal after a Mixing signal is added is done with MUTE. Because the $-\infty$ circuit of Fader is in the step after the addition circuit.

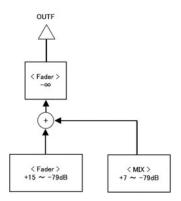
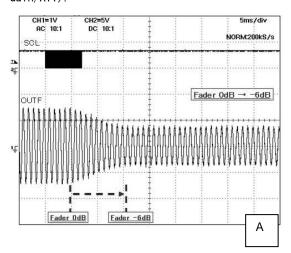
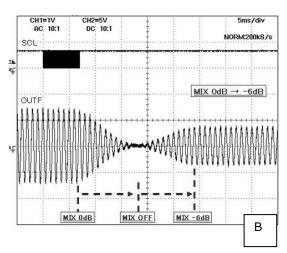


Fig. 32 About Front Fader and Mixing

About advanced switching of Mixing Gain/ATT

When advanced switching of Mixing Gain/ATT works, Mixing becomes the switching movement that it passed through state of Mixing OFF like B (A present setup of Mixing Gain/ATT \rightarrow Mixing OFF \rightarrow A target setup of Mixing Gain/ATT).





Fader Gain/ATT OdB \rightarrow -6dB advanced switching

Mixing Gain/ATT OdB \rightarrow -6dB advanced switching

Fig. 33 Advanced switching movement when Mixing Gain/ATT is changed

●Thermal Derating Curve

About the thermal design by the IC

Characteristics of an IC have a great deal to do with the temperature at which it is used, and exceeding absolute maximum ratings may degrade and destroy elements. Careful consideration must be given to the heat of the IC from the two standpoints of immediate damage and long-term reliability of operation.

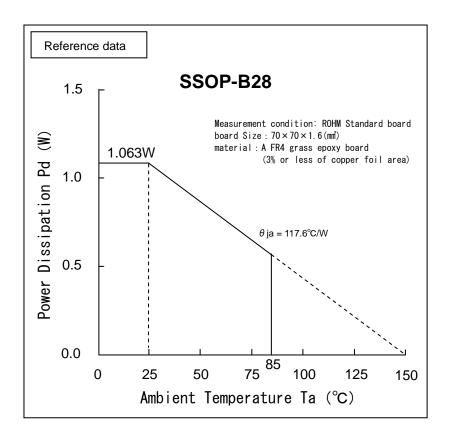
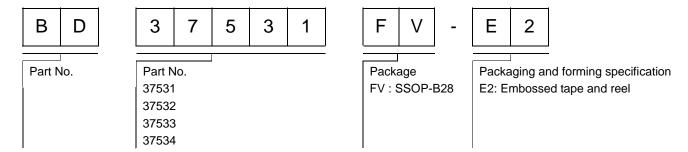


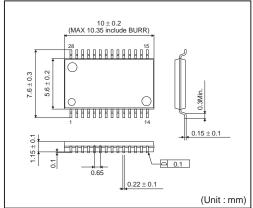
Fig.34 Temperature Derating Curve
Note) Values are actual measurements and are not guaranteed.

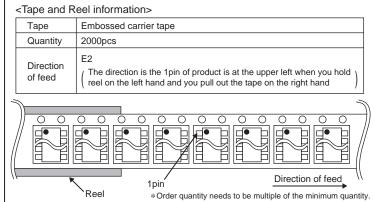
Power dissipation values vary according to the board on which the IC is mounted.

Ordering part number



SSOP-B28





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(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA	
CLASSⅢ	CLASSⅢ	CLASS II b	- CLASSIII	
CLASSIV	CLASSIII	CLASSⅢ		

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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used; if flow soldering method is preferred, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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